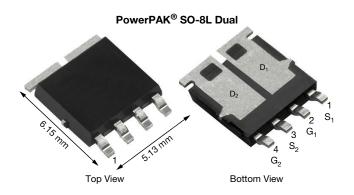


Vishay Siliconix

Automotive Dual N-Channel 40 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY					
V _{DS} (V)	40				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.008				
I _D (A)	30				
Configuration	Dual				

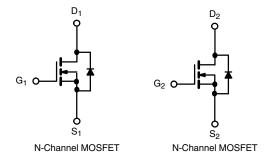
FEATURES

- TrenchFET® Gen IV Power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





ROHS COMPLIANT HALOGEN FREE



ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SQJB46EP-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	LIMIT	UNIT				
Drain-source voltage		V _{DS}	40	V			
Gate-source voltage	V_{GS}	± 20	V				
Continuous drain current	T _C = 25 °C ^a	1	30				
Continuous drain current	T _C = 125 °C	l _D	28.5				
Continuous source current (diode conduction) a	I _S	30	Α				
Pulsed drain current ^b	I _{DM}	120					
Single pulse avalanche current		I _{AS}	21				
Single pulse avalanche energy		E _{AS}	22	mJ			
Maximum power dissipation	T _C = 25 °C	В	34	W			
Maximum power dissipation	T _C = 125 °C	P_{D}	11	VV			
Operating junction and storage temperature range	T _J , T _{stg}	-55 to +175	°C				
Soldering recommendations (peak temperature) ^d		260	O				

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount ^c	R_{thJA}	85	°C/W
unction-to-case (drain)		R _{thJC}	4.3	C/VV

Notes

- a. Package limited
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- c. When mounted on 1" square PCB (FR4 material)
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8L is a leaded package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection



Vishay Siliconix

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static	1			l		•	L
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		40	-	-	V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.3	2.8	3.3	V
Gate-source leakage	I _{GSS}	V _{DS} =	0 V, V _{GS} = ± 20 V	-	-	± 100	nA
		V _{GS} = 0 V	V _{DS} = 40 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 40 V, T _J = 125 °C	-	-	50	μΑ
		V _{GS} = 0 V	V _{DS} = 40 V, T _J = 175 °C	-	-	250	
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 \text{ V}$	25	-		Α
		V _{GS} = 10 V	I _D = 8 A	-	0.0061	0.0080	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 8 A, T _J = 125 °C	-	-	0.0117	Ω
		V _{GS} = 10 V	I _D = 8 A, T _J = 175 °C	-	-	0.0136	
Forward transconductance b	9 _{fs}	$V_{DS} = 15 \text{ V}, I_D = 8 \text{ A}$		-	34	-	S
Dynamic ^b							
Input capacitance	C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	1268	1800	pF
Output capacitance	C _{oss}	$V_{GS} = 0 V$		-	428	600	
Reverse transfer capacitance	C _{rss}			-	32	45	
Total gate charge ^c	Q_g			-	21	32	nC
Gate-source charge ^c	Q_{gs}	V _{GS} = 10 V	$V_{DS} = 20 \text{ V}, I_{D} = 3 \text{ A}$	-	5.8	-	
Gate-drain charge ^c	Q_{gd}			-	4.5	-	
Gate resistance	R_g		f = 1 MHz	1.26	2.54	3.8	Ω
Turn-on delay time ^c	t _{d(on)}			-	12	20	
Rise time ^c	t _r	$V_{DD} =$	20 V, $R_L = 6.67 \Omega$	-	5	10	ns
Turn-off delay time ^c	t _{d(off)}	$I_D \cong 3 A$,	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	19	30	
Fall time ^c	t _f	1		-	6	12	1
Source-Drain Diode Ratings and Chara	acteristics ^b						
Pulsed current ^a	I _{SM}			-	-	120	Α
Forward voltage	V _{SD}	I _F =	I _F = 8 A, V _{GS} = 0 V		0.8	1.2	V
Body diode reverse recovery time	t _{rr}	l _F = 6 A, di/dt = 100 A/μs		-	26	55	ns
Body diode reverse recovery charge	Q _{rr}			-	16	35	nC
Reverse recovery fall time	ta			-	13	-	ne
Reverse recovery rise time	t _b]	-	13	-	ns	
Body diode peak reverse recovery current	I _{RM(REC)}		-	-1.024	-	А	

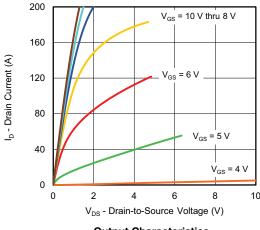
Notes

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

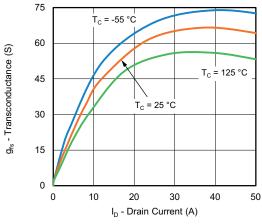
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



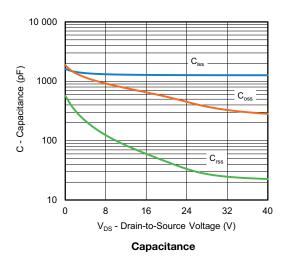
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

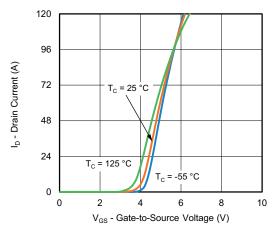




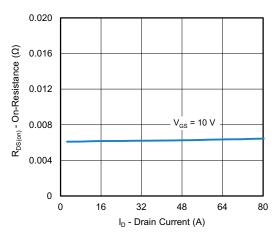


Transconductance

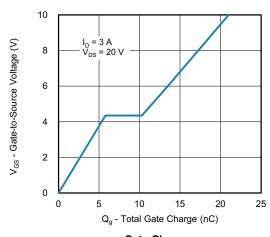




Transfer Characteristics

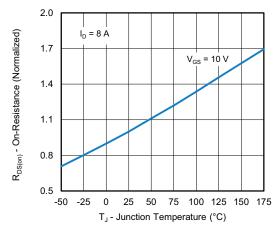


On-Resistance vs. Drain Current

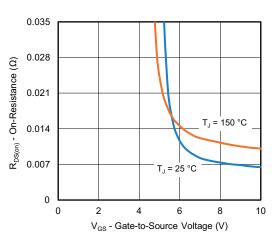




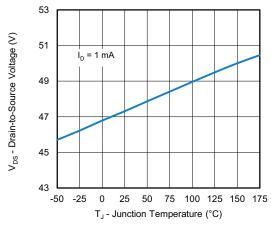
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



On-Resistance vs. Junction Temperature



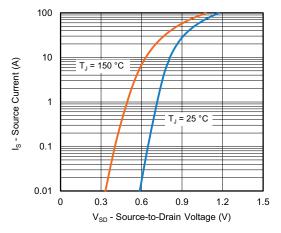
On-Resistance vs. Gate-to-Source Voltage



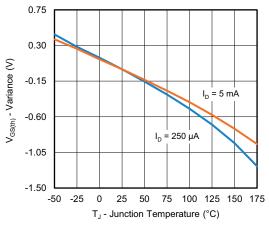
Drain Source Breakdown vs. Junction Temperature

Note

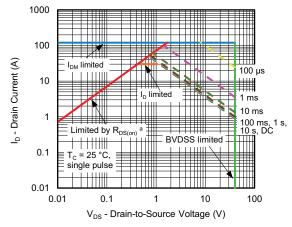
a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



Source Drain Diode Forward Voltage



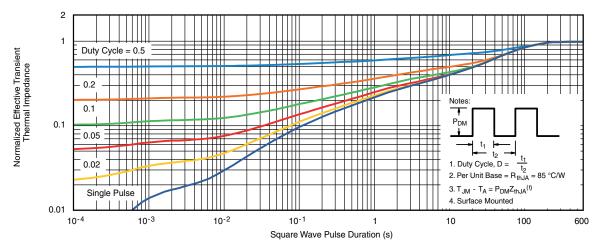
Threshold Voltage



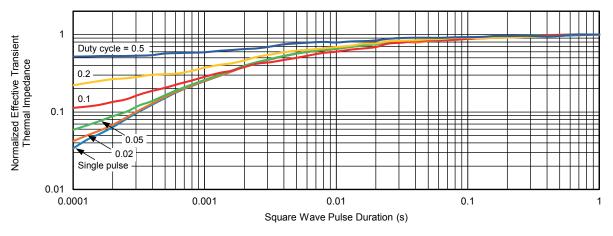
Safe Operating Area



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?77371.



PowerPAK® SO-8L Case Outline 2



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DIM	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX	
Α	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094			0.004		
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC		0.050 BSC			
Е	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	2.75	2.85	2.95	0.108	0.112	0.116	
E3	6.05	6.22	6.40	0.238	0.245	0.252	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
K		0.51			0.020		
W		0.23		0.009			
W1		0.41		0.016			
W2		2.82		0.111			
W3		2.96	96 0.117				
θ	0°	-	10°	0°	-	10°	

DWG: 6044

Note

• Millimeters will govern



PowerPAK® SO-8L Case Outline 1



Topside view

Backside view (single)





Backside view (dual)



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DIM		MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
Α	1.00	1.07	1.14	0.039	0.042	0.045		
A1	0.00	-	0.127	0.00	-	0.005		
b	0.33	0.41	0.48	0.013	0.016	0.019		
b1	0.44	0.51	0.58	0.017	0.020	0.023		
b2	4.80	4.90	5.00	0.189	0.193	0.197		
b3		0.094	•		0.004			
b4		0.47			0.019			
С	0.20	0.25	0.30	0.008	0.010	0.012		
D	5.00	5.13	5.25	0.197	0.202	0.207		
D1	4.80	4.90	5.00	0.189	0.193	0.197		
D2	3.86	3.96	4.06	0.152	0.156	0.160		
D3	1.63	1.73	1.83	0.064	0.068	0.072		
е		1.27 BSC		0.050 BSC				
E	6.05	6.15	6.25	0.238 0.242		0.246		
E1	4.27	4.37	4.47	0.168	0.172	0.176		
E2	3.18	3.28	3.38	0.125	0.129	0.133		
F	-	-	0.15	-	-	0.006		
L	0.62	0.72	0.82	0.024	0.028	0.032		
L1	0.92	1.07	1.22	0.036	0.042	0.048		
K		0.51			0.020			
W		0.23		0.009				
W1		0.41		0.016				
W2		2.82	0.111					
W3		2.96	2.96		0.117			
θ	0°	-	10°	0°	-	10°		

ECN: S19-0643-Rev. E, 05-Aug-2019

DWG: 5976

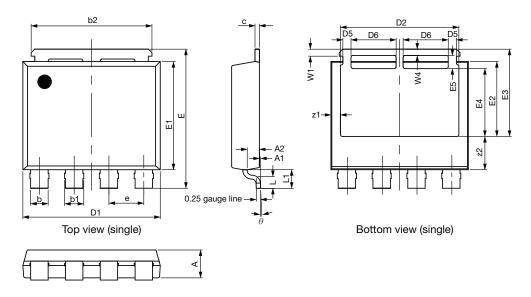
Note

• Millimeters will gover



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PowerPAK® 8 x 8L BWL Case Outline 2



MILLIMETERS		INCHES			
MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
1.50	1.60	1.70	0.059	0.063	0.067
0.00	-	0.127	0.000	-	0.005
0.655	0.705	0.755	0.026	0.028	0.030
0.92	1.00	1.08	0.036	0.039	0.043
1.02	1.10	1.18	0.040	0.043	0.046
6.84	6.94	7.04	0.269	0.273	0.277
0.20	0.25	0.30	0.008	0.010	0.012
7.80	7.90	8.00	0.307	0.311	0.315
6.70	6.80	6.90	0.264	0.268	0.272
0.37	0.47	0.57	0.015	0.019	0.022
2.49	2.59	2.69	0.098	0.102	0.106
1.97	2.00	2.03	0.078	0.079	0.080
7.90	8.00	8.10	0.311	0.315	0.319
6.12	6.22	6.32	0.241	0.245	0.249
4.21	4.31	4.41	0.166	0.170	0.174
4.92	5.02	5.12	0.194	0.198	0.202
3.80	3.90	4.00	0.150	0.154	0.157
0.65	0.75	0.85	0.026	0.030	0.033
0.61	0.68	0.75	0.024	0.027	0.030
1.00	1.07	1.15	0.039	0.042	0.045
0.30	0.40	0.50	0.012	0.016	0.020
0.32	0.37	0.42	0.013	0.015	0.017
0.45	0.55	0.65	0.018	0.022	0.026
1.81	1.91	2.01	0.071	0.075	0.079
0°	-	5°	0°	-	5°
	1.50 0.00 0.655 0.92 1.02 6.84 0.20 7.80 6.70 0.37 2.49 1.97 7.90 6.12 4.21 4.92 3.80 0.65 0.61 1.00 0.30 0.32 0.45 1.81	1.50 1.60 0.00 - 0.655 0.705 0.92 1.00 1.02 1.10 6.84 6.94 0.20 0.25 7.80 7.90 6.70 6.80 0.37 0.47 2.49 2.59 1.97 2.00 7.90 8.00 6.12 6.22 4.21 4.31 4.92 5.02 3.80 3.90 0.65 0.75 0.61 0.68 1.00 1.07 0.30 0.40 0.32 0.37 0.45 0.55 1.81 1.91 0° -	1.50 1.60 1.70 0.00 - 0.127 0.655 0.705 0.755 0.92 1.00 1.08 1.02 1.10 1.18 6.84 6.94 7.04 0.20 0.25 0.30 7.80 7.90 8.00 6.70 6.80 6.90 0.37 0.47 0.57 2.49 2.59 2.69 1.97 2.00 2.03 7.90 8.00 8.10 6.12 6.22 6.32 4.21 4.31 4.41 4.92 5.02 5.12 3.80 3.90 4.00 0.65 0.75 0.85 0.61 0.68 0.75 1.00 1.07 1.15 0.30 0.40 0.50 0.32 0.37 0.42 0.45 0.55 0.65 1.81 1.91 2.01 0° - 5°	1.50 1.60 1.70 0.059 0.00 - 0.127 0.000 0.655 0.705 0.755 0.026 0.92 1.00 1.08 0.036 1.02 1.10 1.18 0.040 6.84 6.94 7.04 0.269 0.20 0.25 0.30 0.008 7.80 7.90 8.00 0.307 6.70 6.80 6.90 0.264 0.37 0.47 0.57 0.015 2.49 2.59 2.69 0.098 1.97 2.00 2.03 0.078 7.90 8.00 8.10 0.311 6.12 6.22 6.32 0.241 4.21 4.31 4.41 0.166 4.92 5.02 5.12 0.194 3.80 3.90 4.00 0.150 0.65 0.75 0.85 0.026 0.61 0.68 0.75 0.024 1.00 1.07 1.15 0.039 0.32	1.50 1.60 1.70 0.059 0.063 0.00 - 0.127 0.000 - 0.655 0.705 0.755 0.026 0.028 0.92 1.00 1.08 0.036 0.039 1.02 1.10 1.18 0.040 0.043 6.84 6.94 7.04 0.269 0.273 0.20 0.25 0.30 0.008 0.010 7.80 7.90 8.00 0.307 0.311 6.70 6.80 6.90 0.264 0.268 0.37 0.47 0.57 0.015 0.019 2.49 2.59 2.69 0.098 0.102 1.97 2.00 2.03 0.078 0.079 7.90 8.00 8.10 0.311 0.315 6.12 6.22 6.32 0.241 0.245 4.21 4.31 4.41 0.166 0.170 4.92 5.02 5.12

ECN: S19-0643-Rev. B, 05-Aug-2019

DWG: 6073

Note

Millimeter will govern

Revison: 05-Aug-2019 1 Document Number: 79736



RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L DUAL



Recommended Minimum Pads Dimensions in mm (inches) Keep-out 6.75 (0.266) x 7.75 (0.305)



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Vishay

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